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11-23-99

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To the Honorable Commissioner of Patents	1012780	046	iginal documents or copy t	hereof.
Name of conveying party(ies): SHIMIZU Toshihiro and SUGAYA Masae Additional name(s) of conveying party(ie	s) attached? No		eddress of receiving part	
3. Nature of conveyance:				
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	Additional name(s) & address(es) attacl		s) & address(es) attache	₃d? No
4. Application number(s) or patent nu Title: Solid Preparation If this document is being filed toget A. Patent Application No.(s)		on, the execution o		_ ,
	Additional number	l ers attached? <u>No</u>		
5. Name and address of party to whom correspondence concerning document should be mailed: 6. Total number			of applications and pate	ts involved: <u>1</u>
Name: Philippe Y. Riesen Takeda Chemical Industries, Ltd. Intellectual Property Department		7. Total fee (3	7 C.F.R. §3.41)	. \$40.00
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/01/1999 GCLATER COOKERS		8. Deposit acc	ount number: 500799	
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9. Statement and signature. To the best of my knowledge and belied document. Philippe Y. Riesen (No. 35,657) Name of the Person signing Total number	ef, the foregoing information Signature of pages including cove	2	November 19, 19	
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Washington, D.C. 20231

PATENT REEL: 010575 FRAME: 0459

ASSIGNMENT

For good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, each undersigned inventor hereby sells and assigns, to TAKEDA CHEMICAL INDUSTRIES LTD., a corporation of Japan, 1–1, Doshomachi 4–chome, Chuo–ku, Osaka, Japan (hereinafter ASSIGNEE) all right, title and interest for the United States, its territories and possessions in and to the following invention and U.S. application filed thereon, and the entire right, title and interest in and to any and all Letters Patents which may be granted therefor in the United States, to be held and enjoyed by said ASSIGNEE, its successors, legal representatives and assigns to the full end of the term or terms for which any and all such Letters Patent may be granted as fully and entirely as would have been held and enjoyed by the undersigned had this Assignment not been made.

United States Patent Application :						
[XX]	executed cond	currently herewith				
[]	executed on					
[]	Serial No.	Filed				

Title of Invention: Solid Preparation

Each of the undersigned acknowledges that this sale and assignment includes any and all divisions or continuations of said United States Patent application, and any and all Letters Patent of the United States which may issue on any such applications, including any and all reissues or extensions thereof.

Each of the undersigned hereby authorizes and requests the Commissioner of Patents and Trademarks to issue any and all such Letters Patent to said ASSIGNEE, its successors or assigns in accordance herewith;

Each of the undersigned warrants and covenants that he has the full and unencumbered right to sell and assign the interests herein sold and assigned and that he has not executed and will not execute any document or instrument in conflict herewith;

Each of the undersigned further covenants and agrees he will communicate to said ASSIGNEE, its successors, legal representatives or assigns all information known to him relating to said invention or patent application and that he will execute and deliver any papers, make all rightful oaths, assist in and testify in any related proceedings including interferences or lawsuits concerning this application or continuation, division or reissue thereof, and perform all other lawful acts deemed necessary or desirable by said ASSIGNEE, its successors, legal representatives or assigns to obtain a grant of a valid United States Patent on said invention;

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PATENT REEL: 010575 FRAME: 0460

Each of the undersigned hereby grants ASSIGNEE and its legal representatives, the power to insert in this Assignment any further identification which may be necessary or desirable to comply with the rules of the U.S. Patent and Trademark Office for recordation of this Assignment and specifically, the power to insert in the space provided above, the filing date and application number of the application when known.

In witness hereof, executed by the undersigned on the date(s) opposite the undersigned names.

NAMES AND SIGNATURES OF INVENTORS					
1.Name: SHIMIZU Toshihiro	Signature: Joshihiro Shinizu	Date: 1 /08/99			
2.Name: SUGAYA Masae	Signature: Masal Sugaya	Date: 10/08/99			
3.Name:	Signature:	Date:			
4.Name:	Signature:	Date:			
5.Name:	Signature:	Date:			
6.Name:	Signature:	Date:			
NAMES AND SIGNATURES OF WITNESSES*					
Name/OKUMURA Yorchi	Signature:	Date:			
For: 1 and 2	Cen Com	10/01/99			
Name/KITAO Tadaaki	Signature: Vadaahi Kitao	Date:			
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For:					
Name/	Signature:	Date:			
For:					
Name/	Signature:	Date:			
For:					
Name/	Signature:	Date:			
For:	Link investor(a) you are signing for by writing the				

^{*}Notice for Witnesses! Please indicate which inventor(s) you are signing for by writing the corresponding numbers after "For:"

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PATENT REEL: 010575 FRAME: 0461

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